

The AUDACE Collaborative Project

A joint innovation program between Thales, Valeo, SMEs & Research Labs on mechatronics devices reliability

Philippe POUGNET Reliability Expert

Version 1 – December 6th 2012

Agenda

1 • Introduction

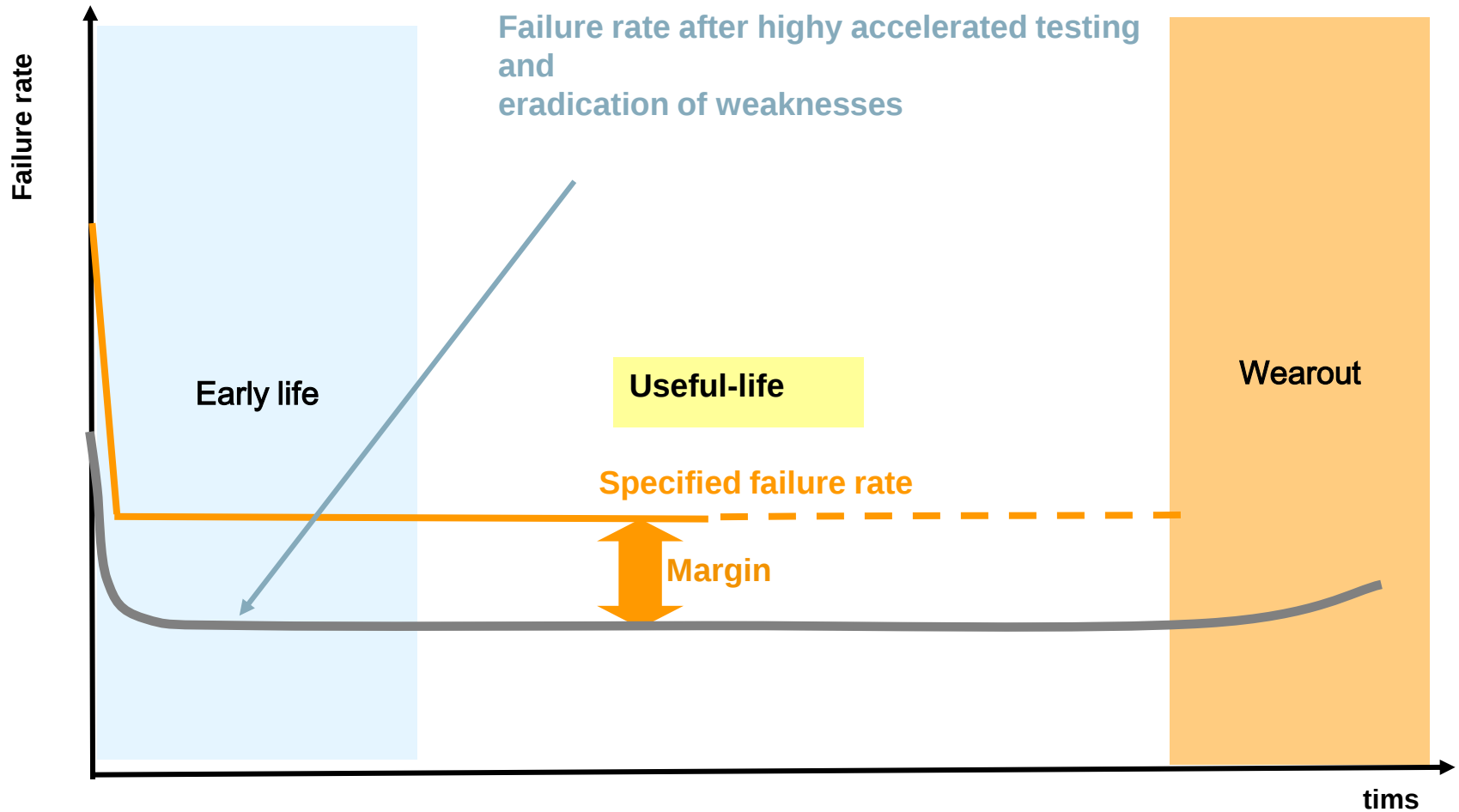
2 • Project management

3 WorkPackages

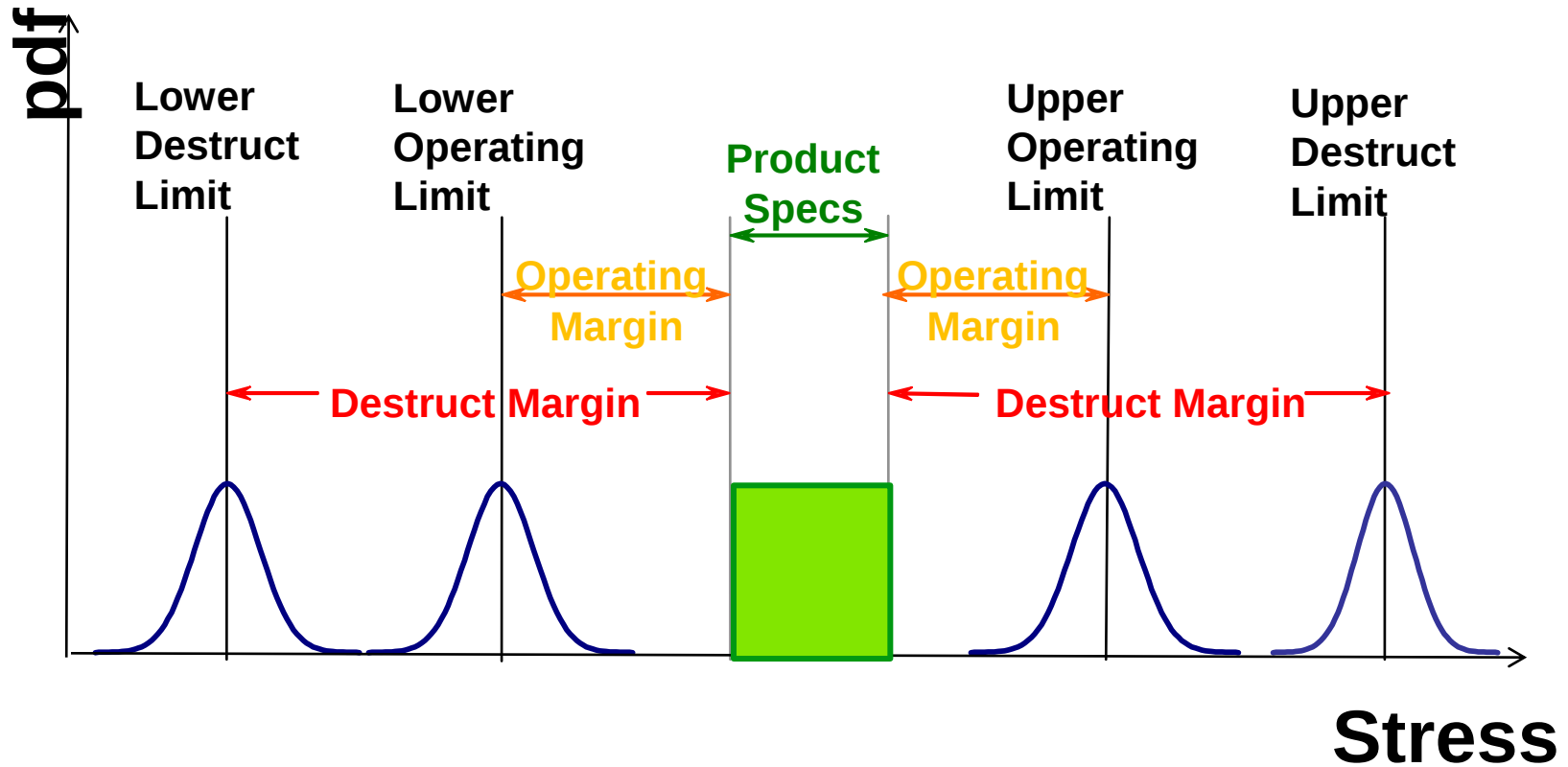
4 Conclusion

Date + numérotation

Reliability targets



Robustness Margins





Audace

Project overview

Project Description

« Analyse des caUses de DéfaillAnces des Composants des systèmes mEcatroniques embarqués »



A Mov'eo Cluster program

Budget : 8 790 k€

Public funding: 5 861k€

Duration : 48 mois

Start :...October 1st 2008.....

Pilot : THALES, VALEO,

Partners : PRESTO, LIGERON, MB ELECTRONIQUE,

CEVAA, CETIM, UVSQ, UNIV ROUEN, INSA, ECIME, IRSEEM, ENSICAEN



THALES



Yvelines
Conseil général



Goals

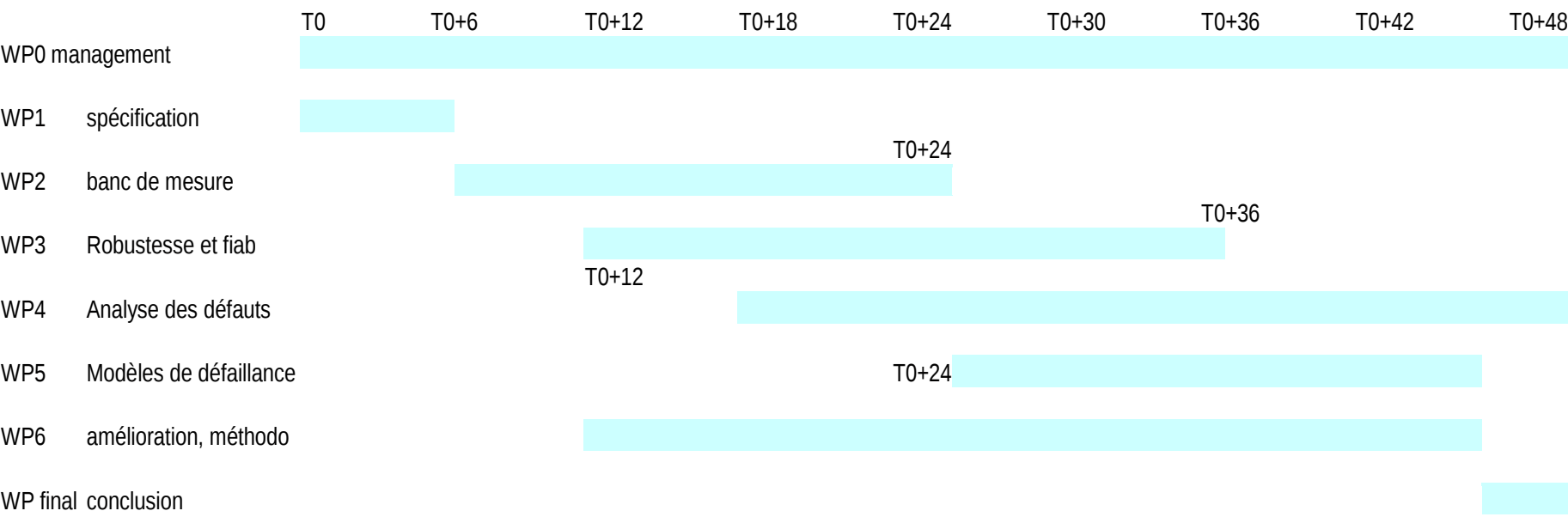
- **Develop a Reliability Engineering Methodology**
 - ➔ Reliability & Robustness Characterization Equipments
 - ➔ Methodologies
 - Future products and technologies reliability
(PRO-ACTIVE)
 - Analyze failures of existing products
(RE-ACTIVE)
- **Launch a Test Platform**

Work Packages

WP1 Specifications	WP2 Stress effect Measurements	WP3 Robustness & Reliability	WP4 Defect Analysis	WP5 Failure models	WP6 Reliability Improvement Methodology
WP1.1 Mission profile	WP2.1 Chip temperature	WP 3.1 Super HAT Test bench	WP4.1 Physics measurements	WP5.1 Multiphysics modeling	WP6.1 Design architecture improvmnt
WP1.2 Qualification test	WP2.2 EM stress Test bench	WP3.2 Reliability Test bench	WP4.2 Package Constituants measurement	WP5.2 Predictive Reliability Models	WP6.2 Design Rules
WP1.3 Components & Systems of interest	WP2.3 Mechanical deformations	WP3.3 EOVS Test bench			

Understand & Control Failure Mechanisms

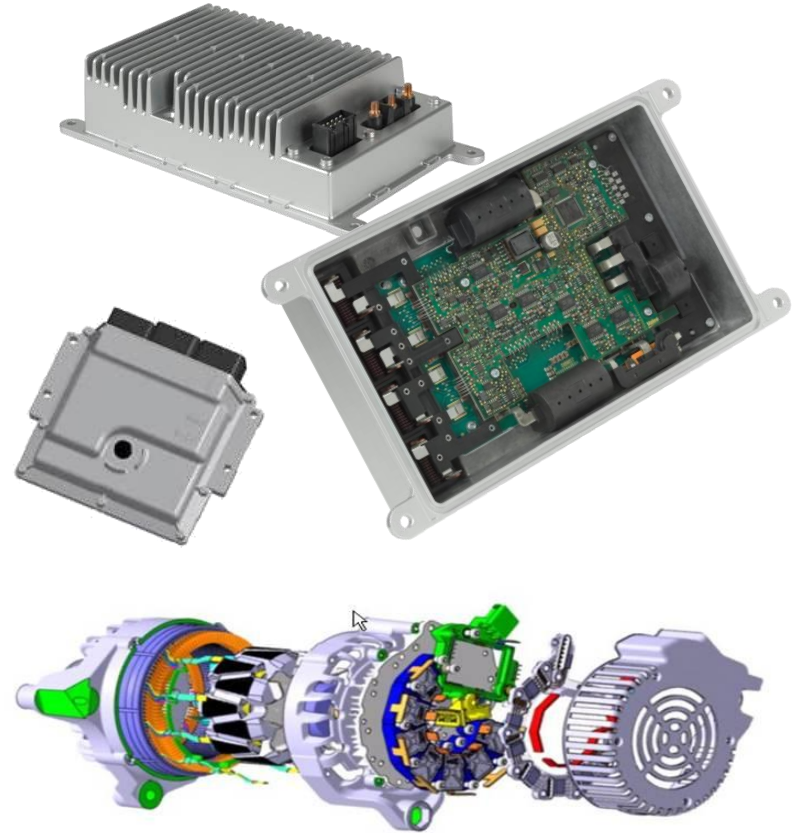
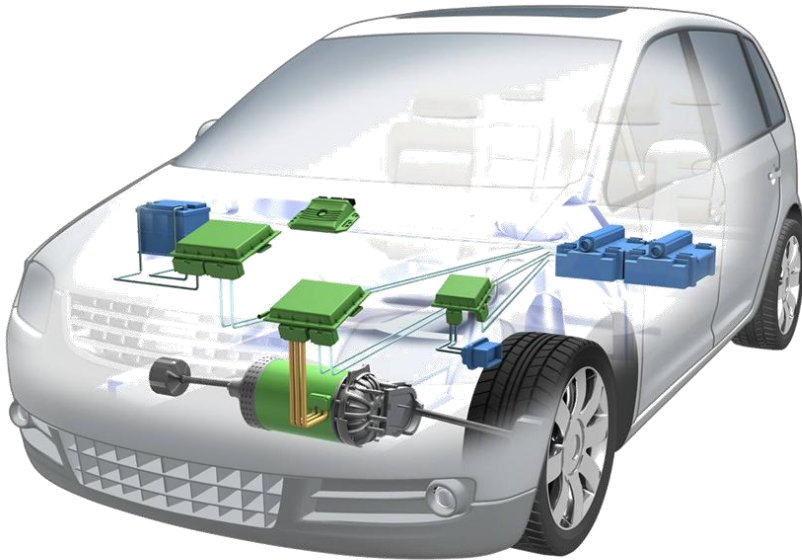
Time Plan



Audace WP1

Demonstrators

Reliability of innovative embedded mechatronic devices



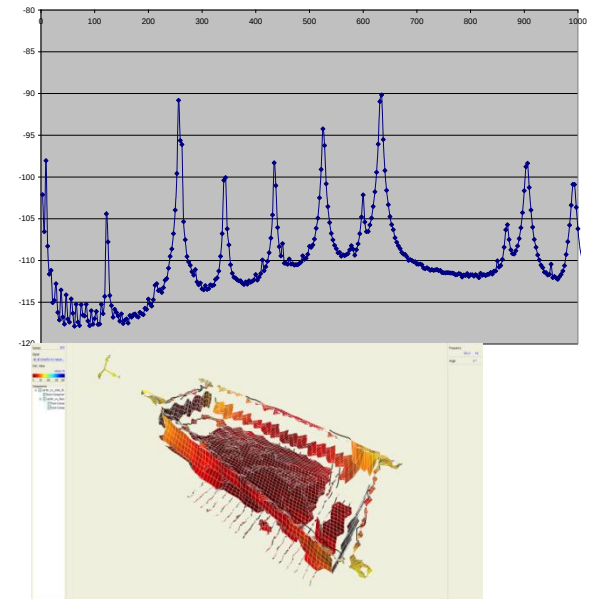
Audace WP2

Identify the failure modes

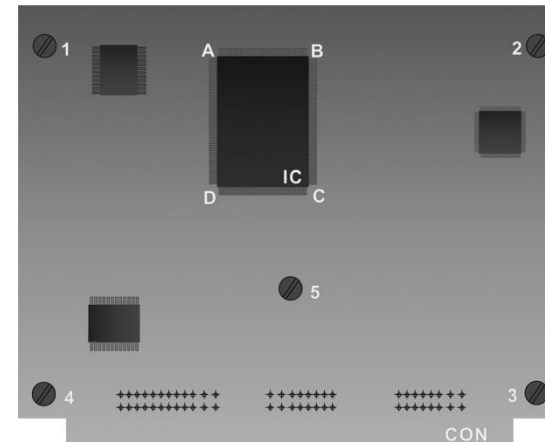
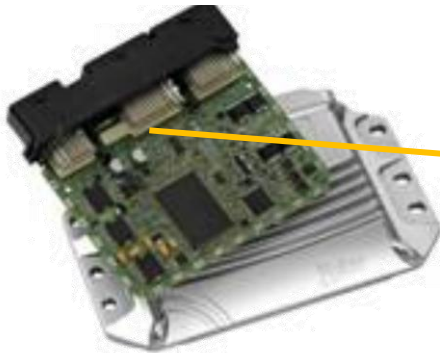
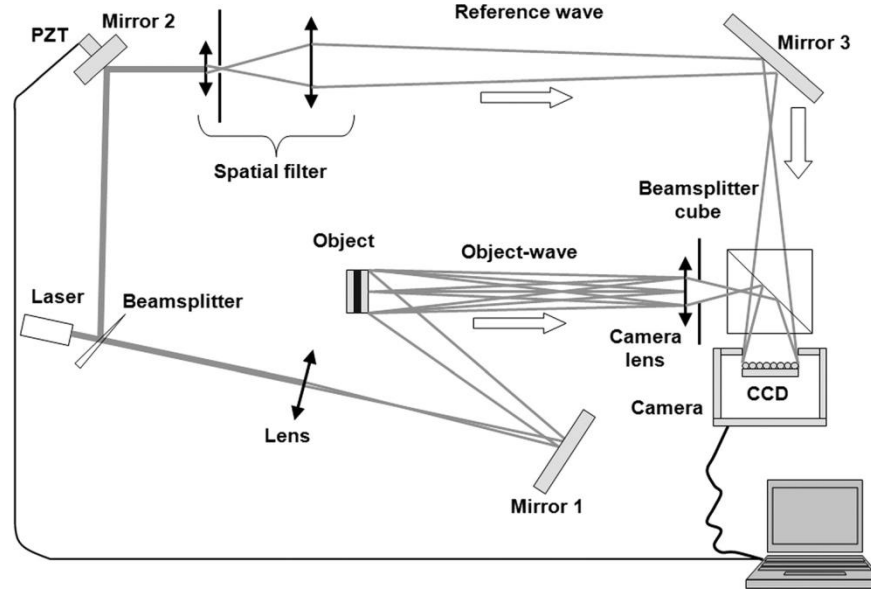
Modal Analysis Test Bench: Laser Vibrometry

◆ Main features:

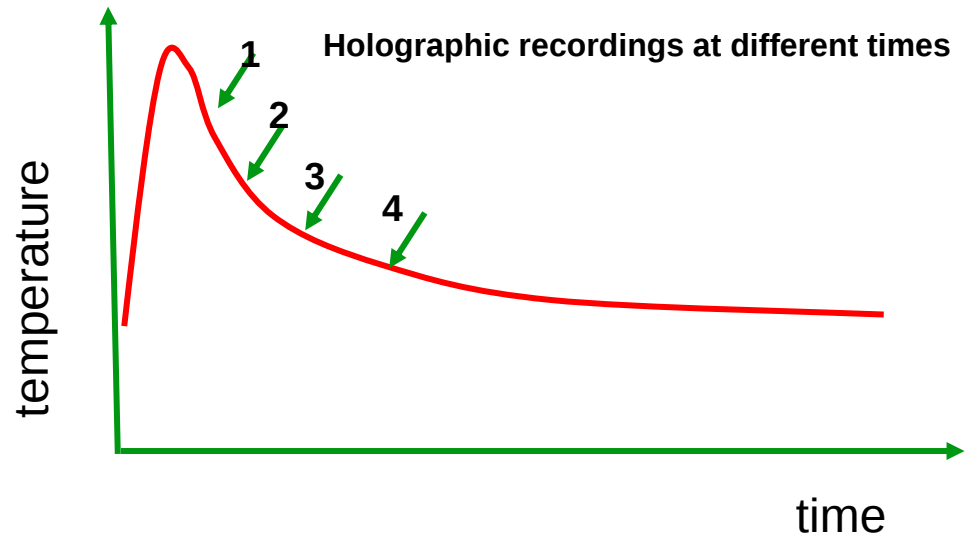
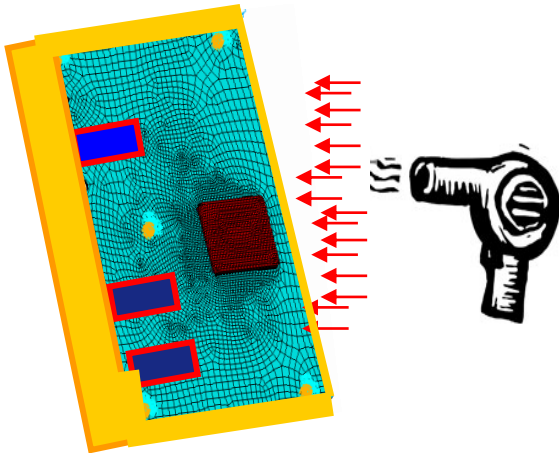
- non contact optical technique (components, assembled circuit boards)
- High density mesh measurements
- Rapid response time
- Identifies Eigen frequencies and Eigen modes and FRF



Phase-stepped Laser Speckle Interferometry

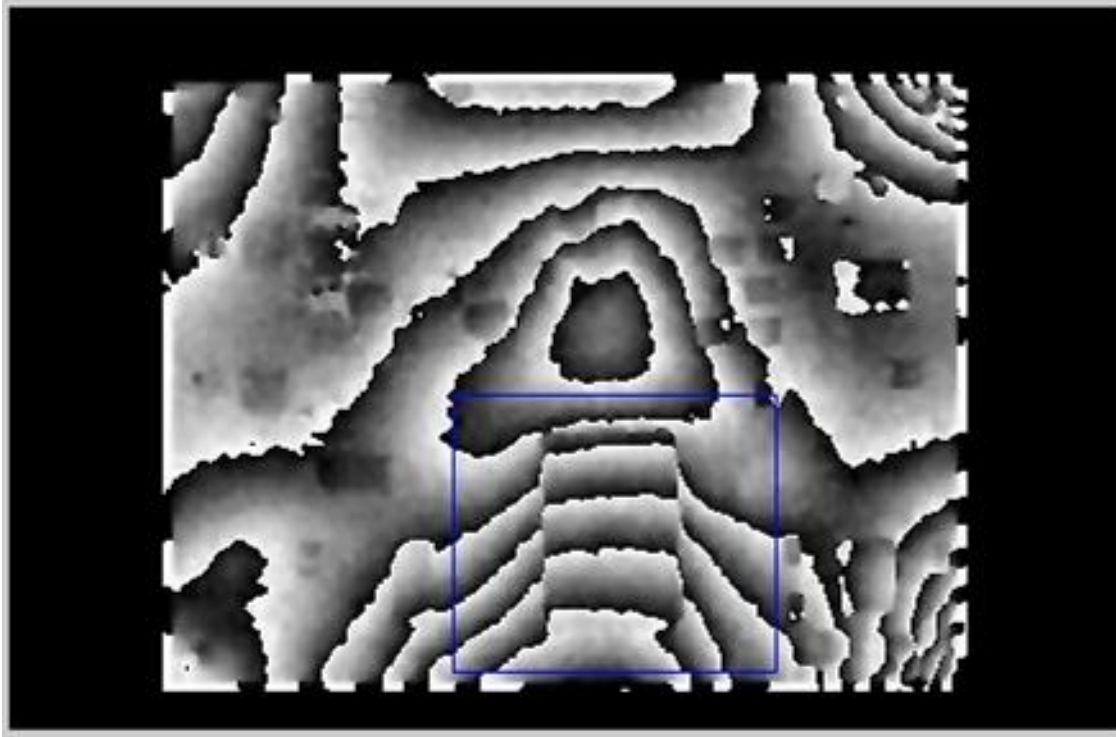


Phase stepped Laser Speckle Interferometry

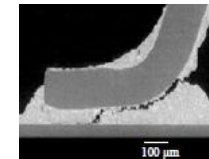
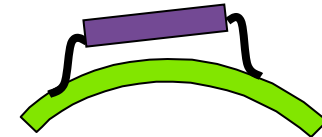
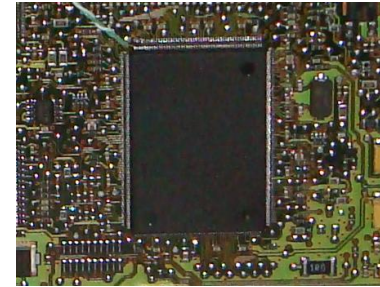
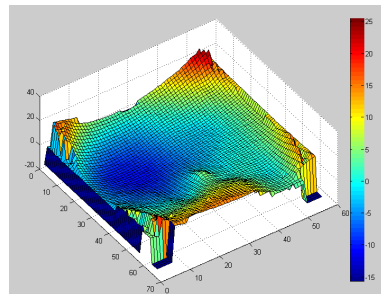


Thermally induced deformation

Phase-stepped Laser Speckle Interferometry



Full field out of plane deformations



Audace WP3

Robustness Margins characterization

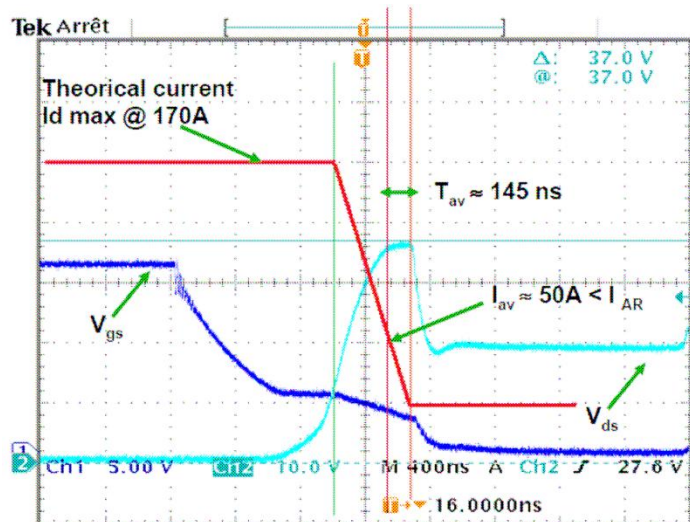
Lifetime characterization in operating conditions



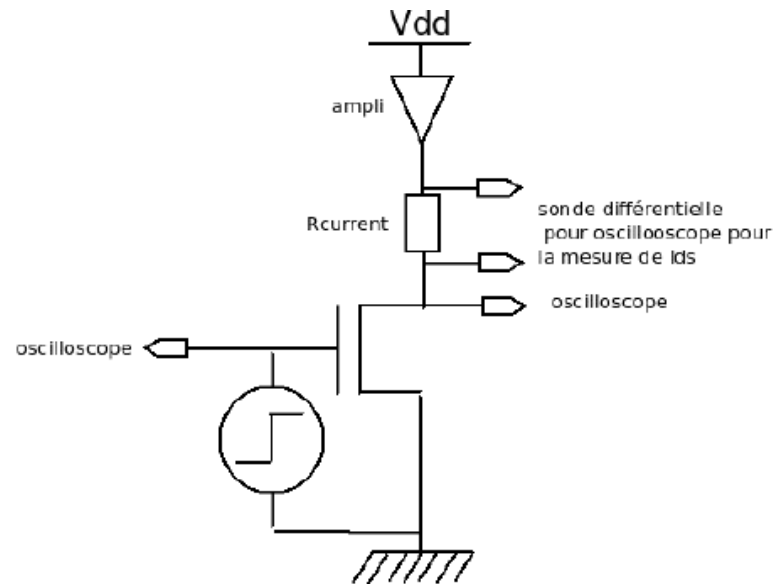
Highly Accelerated Testing + Humidity

- Thermal environment
 - -100°C / 200°C
 - 60°C/mn
- Vibration environment
 - Random vibratons
 - 0 to 50 Grms between 10 Hz and 10 kHz
- Humid environment
- Combination of stresses

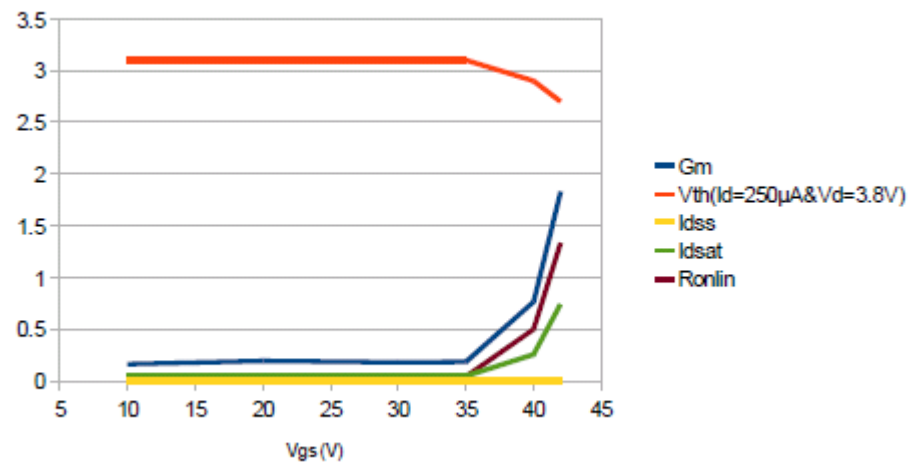
EOVS test bench



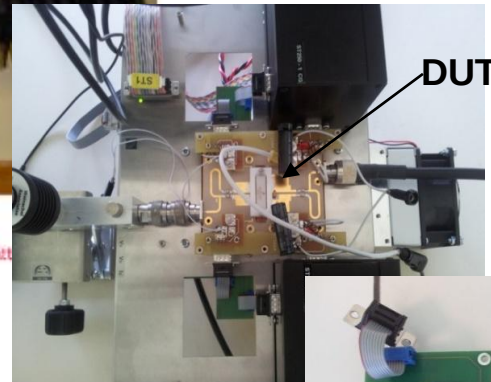
V_{gs} , V_{ds} , I_{ds} waveforms



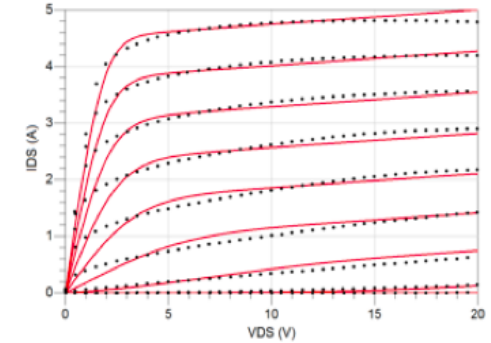
Transient power generator
 $I_{ds} = f(V_{ds})$



Test benches: Pulsed RF HTOL & CW RF + EM

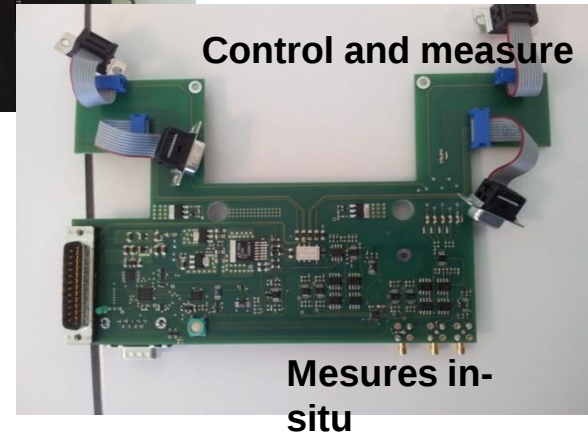
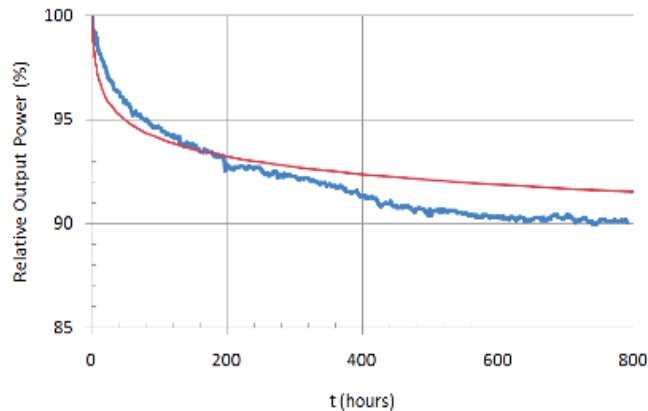


ID(VD) **simulé** et **mesuré**



Atténuateur utilisable Coupleur 30dB Circulateur 20dB D. S. T. Tuner manuel

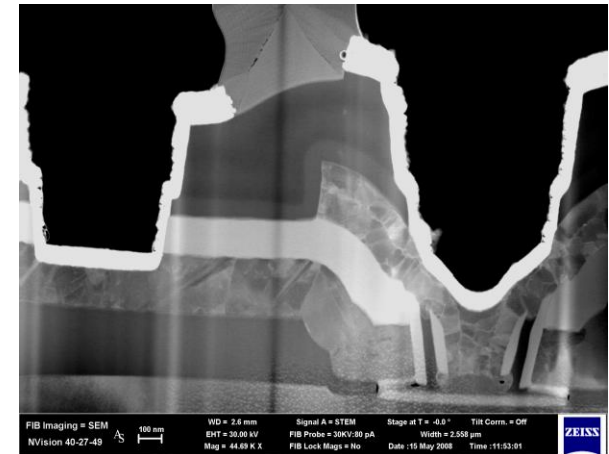
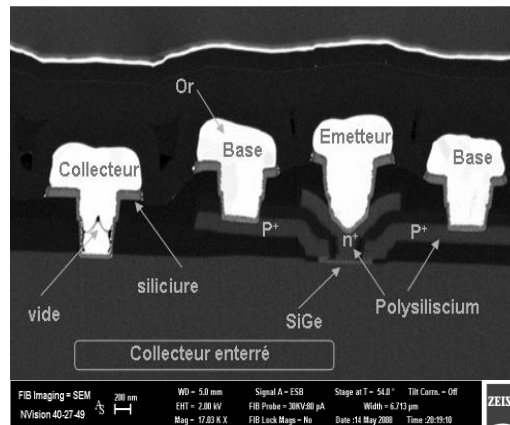
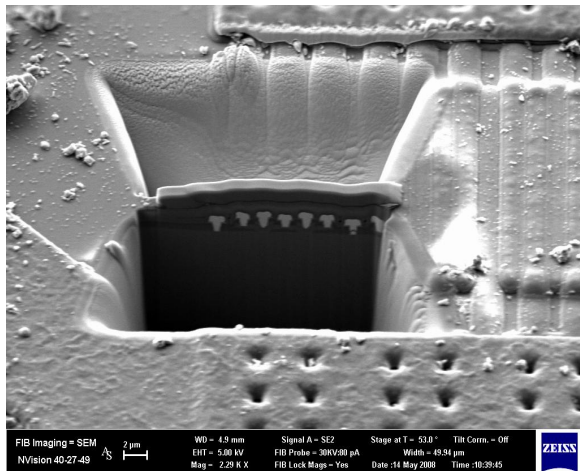
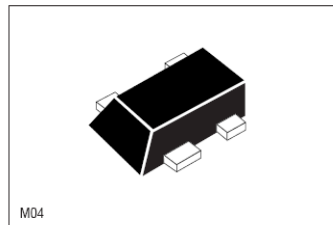
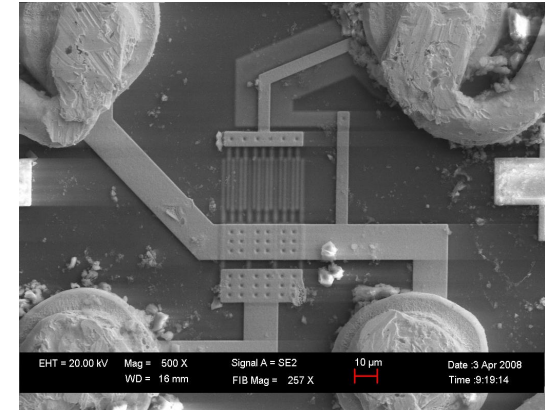
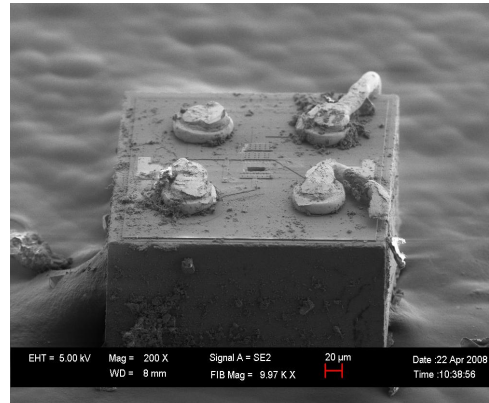
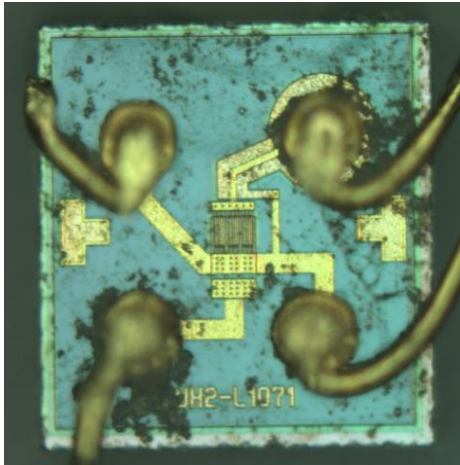
Puissance de sortie **simulée** et **mesurée**



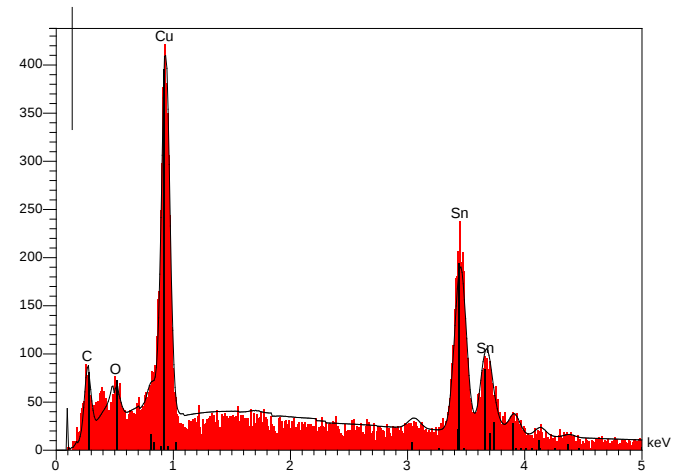
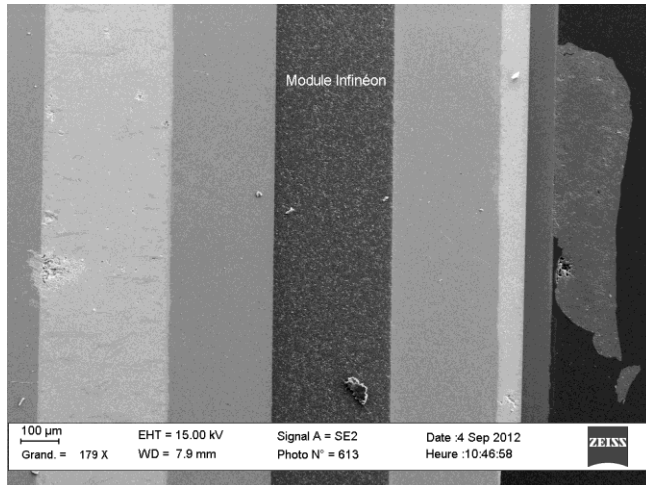
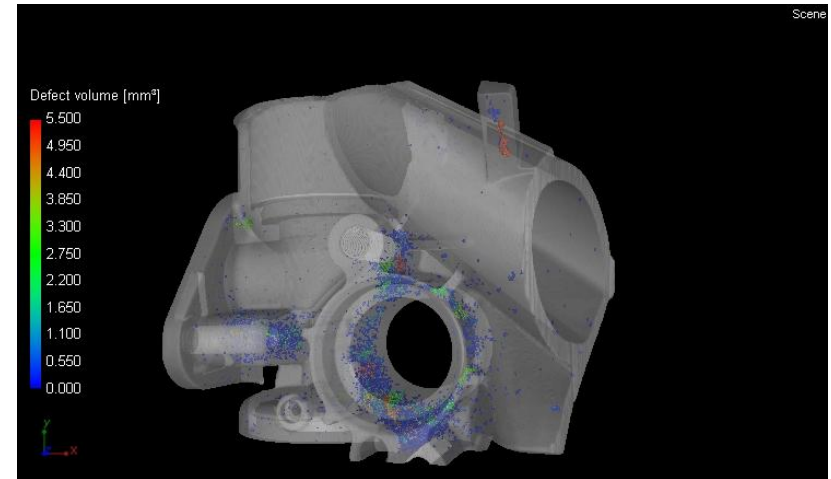
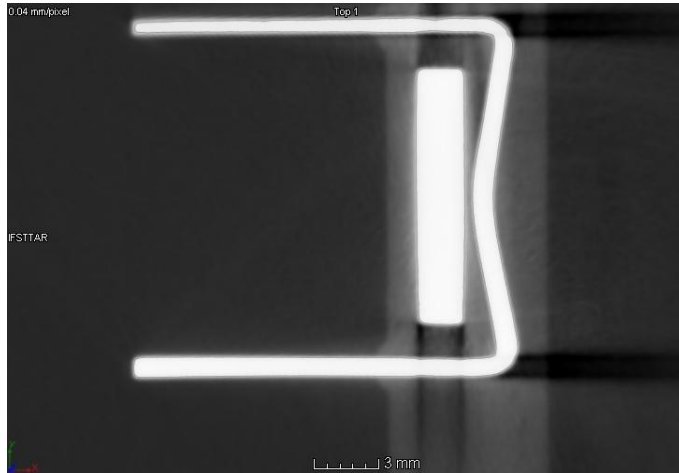
Audace WP4

Failure Analysis

Failure Analysis



Failure Analysis



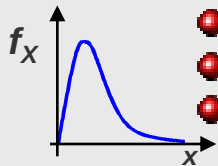
Audace WP5 & WP6

Modelling & Simulation

Optimization

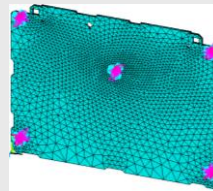
A Probabilistic Approach to Robustness

Uncertainties or variability



- Material properties
- Geometry
- Thermal loading

Mechanical model



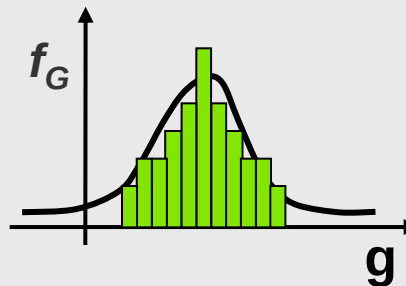
- FEM
- Fatigue...

Response surface method

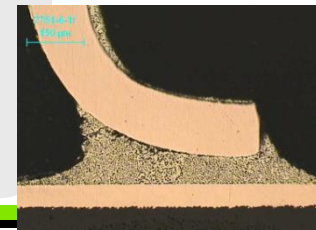
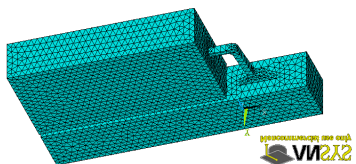
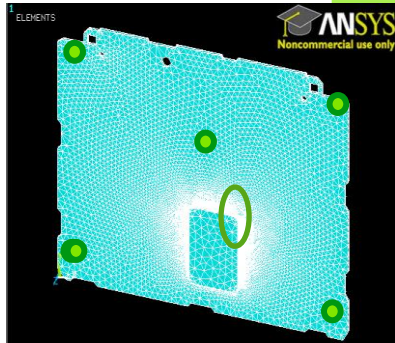
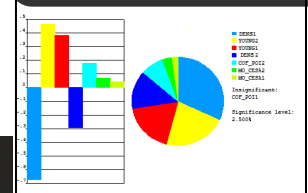
$$\tilde{\varepsilon}_p = c + \sum_{i=1}^n b_i x_i + \sum_{i=1}^n \sum_{j=1}^n a_{ij} x_i x_j$$

**Mechanical -reliability
coupling Monte Carlo Simulations with
Latin Hypercube sampling**

Response distribution



Sensitivity analysis



Conclusion

- 1 A collaborative research program addressing the reliability failure mechanisms of mechatronic devices**
- 2 A design methodology that insures the realization of reliability goals**
- 3 A Test Platform proposing solutions to reliability issues**

Thank you for your attention!



Enabling a better automotive world